REMARKS

Reconsideration of this application is respectfully requested. Claim 1 has been amended to

remove restrictions to cleaning gasses and to positively recie various fluid couplings and physical

orientations of elements of the chemical vapor deposition system. Support for these amendments may be

found in the specification as filed, for example at paragraphs 21-23, 26 and 27. No new matter is added.

Claim 1 is patentable over van Os, US 5,792,272, which the office action concedes fails to teach a

first gas source. Office Action at p.9.

Claim 1 is further patentable over van Os in view of Murugesh, US 6,450,117, which is cited for

describing a gas source. Even if such a gas source were present in the system described by van Os,

however, van Os would still not teach all of the features presently recited in claim 1. For example, the

system described in van Os does not include a lid supporting a shower head disposed within the chemical

vapor deposition chamber and separate from the first gas distribution channel, wherein that lid has an

interior rim including a plurality of cleaning gas injection ports each of which is fluidly connected to a gas distribution channel, and various ones of which are oriented at different angles with respect to an

interior of a wall of the chemical vapor deposition chamber, said wall being attached to said lid, as

presently claimed.

If there are any additional fees due in connection with this communication, please charge Deposit

Account No. 19-3140.

Respectfully submitted,

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4